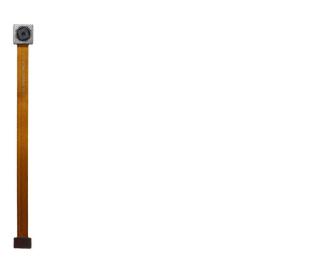


YDS-E7MA-OV5645 V2.1

5MP OmniVision OV5645 MIPI Interface Auto Focus Camera Module



Front View

Back View

Specifications

Camera Module No.	YDS-E7MA-OV5645 V2.1
Resolution	5MP
Image Sensor	OV5645
Sensor Type	1/4"
Pixel Size	1.4 um x 1.4 um
EFL	3.29 mm
F.NO	2.80
Pixel	2592 x 1944
View Angle	68.7°(DFOV) 58.1°(HFOV) 45.0°(VFOV)
Lens Dimensions	8.50 x 8.50 x 5.17 mm
Module Size	100.00 x 8.50 mm
Module Type	Auto Focus
Interface	MIPI
Auto Focus VCM Driver IC	Embedded
Lens Model	YDS-LENS-M5101
Lens Type	650nm IR Cut
Operating Temperature	-30°C to +70°C
Mating Connector	AXK724147G

www.YDSCAM.com sales@ydscam.com Phone (WeChat, QQ): (+86) 177 2732 6718





5MP OmniVision OV5645 MIPI Interface Auto Focus Camera Module



www.YDSCAM.com_sales@ydscam.com_Phone (WeChat, QQ): (+86) 177 2732 6718

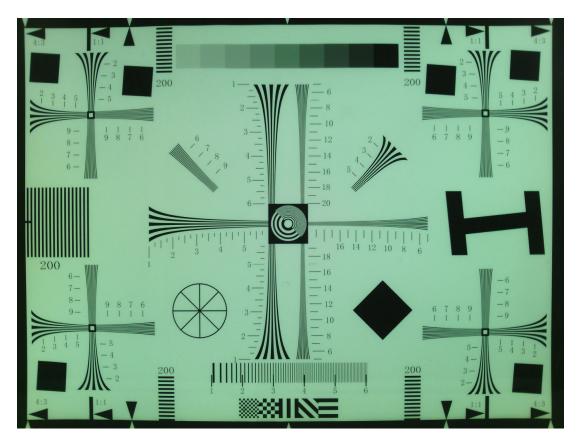
ν.	N →	
Paran 1, Se Image : Pixel: Lens T Importo (exterr	PIN PIN PIN PIN PIN PIN PIN PIN	
Parameter: 1. Sensor specification: Image Sensor: 0V5645 Pixel: 1.4um×1.4um Lens Type: 1/4 Important Voltage Description: DVDD1.5V (external power supply); A B	SIGNAL DATAP1 IOVDD1.8V DVDD1.5V NC PWDN NC RESET SCL AVDD2.8V SDA AGND NC GND NC DATAN0 NC CLKN NC CLKN GND MC CLKP GND MC CLKP GND	RoHS
	TOP VIEW 100±0.20 8.50±0.10 8.50±0.10 8.50±0.10 100±0.20 8.50±0.10 100±0.20	α
2 Lens specification FOV: 68.7° F/NO.: 2.8 TV distortion: <1.0% Focal length: 3.29mm Composition: 4P+IR FILTER IR Cut Coating: 650nm±10nm	5.07±0.20(Mic 4.92±0.20(V 87±0.20(Norr 65.5	_
pecification: <1.0% 3.29mm 4P+IR FILTER : 650nm±10nm@50% C		C
Designed By Checked By	₩ 68.7° 68.7° 60.45+0.05 7.43+0.05 7.43+0.05 7.43+0.05	-
Kevin Aouly_Yan (Version V1.0
Model Name: Projection Type: Unit: Third Angle	41455 Chan	Infor First
E7MA-0V5645 V2.1 mm Material: e: Sheet: Version: 1:1 1 of 1 Version: 1:1 1 1	■8.00 双面背胶T=0	Information
3 645 V2.1 Version: 1/0	9-24-2020 1 2 1	Date 10-29-2018

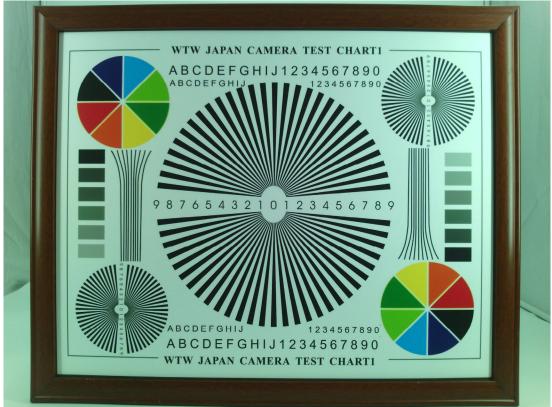
Real Test Images E7MA-OV5645 V2.1





Real Test Images E7MA-OV5645 V2.1





OV5645 5-megapixel product brief





High Quality 5-Megapixel Photography and HD Video for Low-Cost Mobile Devices

available in a lead-free package OmniVision's OV5645 is a high performance, 5-megapixel system-on-chip (SOC) ideally suited for the cost-sensitive segment of the mobile handset market. The CameraChip™ sensor's single MIPI port replaces both a bandwidth-limited DVP interface and a costly embedded JPEG compressor, allowing the new OV5645 sensor to save significant silicon area and cost. An embedded autofocus control with voice coil motor driver offers further cost savings for the end user, making the OV5645 a highly attractive alternative to other 5-megapixel sensors currently on the market.

The OV5645 also features a new picture-in-picture (PIP) architecture that offers an easy-to-implement, low-cost dual camera system solution for mobile handsets and smartphones. The feature is based on a master/slave configuration where a front-facing camera (OV7965) can be connected through the OV5645 master camera, enabling a two-camera system with PIP functionality without the need for an additional MIPI interface into the baseband processor.

Built on OmniVision's 1.4-micron OmniBSI[™] pixel architecture, the OV5645 offers high performance 5-megapixel photography and 720p HD video at 60 frames per second (FPS) and 1080p HD video at 30 FPS with complete user control over formatting and output data transfer. The sensor's 720p HD video is captured in full field-of-view with 2 x 2 binning, which doubles the sensitivity and improves the signal-to-noise ratio (SNR). A unique post-binning, re-sampling filter function removes zigzag artifacts around slant edges and minimizes spatial artifacts to deliver even sharper, crisper color images.

Find out more at www.ovt.com.



Applications

- Cellular Phones
- Toys

- PC Multimedia
- Digital Still Cameras

Product Features

- 1.4 µm x 1.4 µm pixel with OmniBSI+™ technology for high performance (high sensitivity, low crosstalk, low noise, improved quantum efficiency)
- optical size of 1/4"
- automatic image control functions: automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), automatic 50/60 Hz luminance detection, and automatic blacklevel calibration (ABLC)
 dual lane MIPI output interface
- image quality controls: color saturation, embedded 1.5V regulator for core hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling
- support for output formats: RAW RGB, RGB565/555/444, YUV422/420, YCbCr422
- support for video or snapshot operations
- support for internal and external frame synchronization for frame exposure mode
- support for LED and flash strobe mode

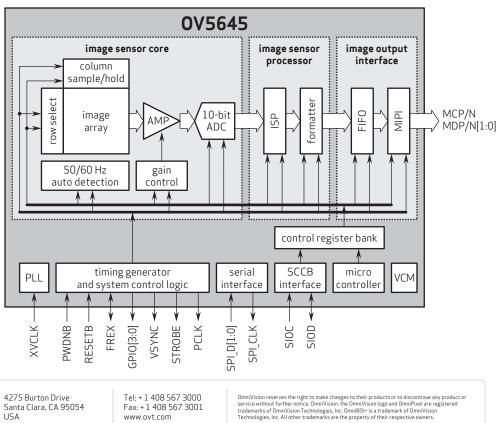
- support for horizontal and vertical sub-sampling, binning
- support for minimizing artifacts on binned image
- support for data compression output
- support for anti-shake standard serial SCCB interface
- power
- programmable I/O drive capability, I/O tri-state configurability
- support for black sun cancellation
- support for images sizes: 5 megapixel, and any arbitrary size scaling down from 5 megapixel
- support for auto focus control (AFC) with embedded AF VCM driver
- embedded microcontroller
- suitable for module size of 8.5 x 8.5 x <6mm with both CSP and RW packaging

- OV05645-A66A (color, lead-free, 66-pin CSP3)
- OV05645-G04A (color, chip probing, 200 µm backgrinding, reconstructed wafer)

Product Specifications

- active array size: 2592 x 1944
- power supply: core: 1.5V ±5% (with embedded 1.5 regulator) - analog: 2.6 - 3.0V (2.8V typical) - I/O: 1.8V / 2.8V
- temperature range:
 operating: -30°C to 70°C junction
- temperature stable image: 0°C to 50°C junction temperature
- output formats: 8-/10-bit RGB RAW, RGB565/555/444, YUV422/420, YCbCr422 output
- lens size: 1/4"
- lens chief ray angle: 29.1°

- input clock frequency: 6 27 MHz
- max S/N ratio: 36 dB
- maximum image transfer rate:
 QSXGA (2592X1944): 15 fps - 1080p: 30 fps - 1280x960: 45 fps
 - 720p: 60 fps
- shutter: rolling shutter / frame exposure
- maximum exposure interval: 1964 × t_{ROW}
- **pixel size:** 1.4 μm x 1.4 μm
- image area: 3673.6 µm x 2738.4 µm
- package/die dimensions:
 CSP3: 6200 μm x 4860 μm
 COB: 6190 μm x 4850 μm





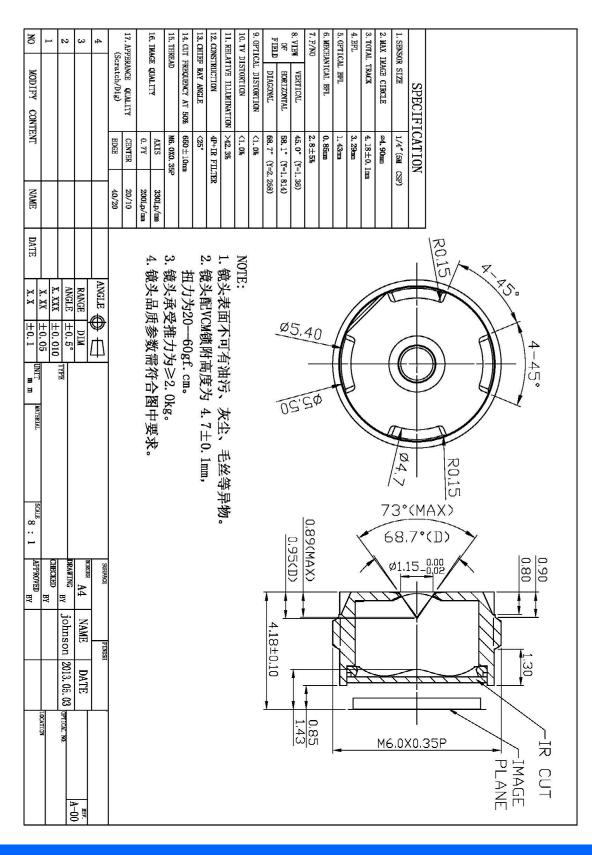
Functional Block Diagram

OV5645

your best camera partner

YDS-LENS-M5101

DS



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Panasonic ideas for life



Without retention fitting



Header

With retention fitting





FEATURES

1.0.4 mm pitch and support for mated heights of up to 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm, 3.5 mm, and 4.0 mm. 2. Strong resistance to adverse environments! Utilizes **TOUGH CONTRET** construction

for high contact reliability.

1) Contacts are highly resistant to shock caused by dropping and employ our original bellows contact construction.

Contacts are formed by bending a thin metal sheet, which provides the contact parts with adequate spring characteristics ensuring greater resistance to prying forces and drop impacts

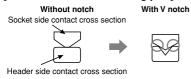


2) V notch construction used for excellent resistance against foreign matters.

What is V notch construction?

By using the edge for the contacting part and increasing contact pressure per unit area, the effectiveness in removing flux and contaminants is increased compared to its predecessor. This is also effective in preventing the trapping of contaminants.

[Cross section of contacting part]



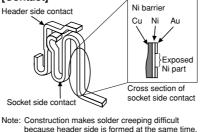
NARROW-PITCH CONNECTORS FOR **BOARD-TO-BOARD** AND BOARD-TO-FPC CONNECTION

3) Use of Ni barrier construction is standard. Highly effective against solder creeping.

What is Ni barrier construction?

By providing an exposed nickel part on the gold (Au) plated contact, solder creeping is prevented despite the ultra low profile.

[Contact]

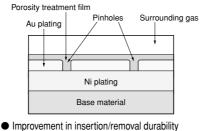


4) Porosity treatment applied for

improved resistance against corrosion.

What is porosity treatment?

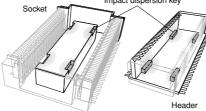
This treatment consists of coating the surface with a very thin film to seal pinholes in the gold plating. This porosity treatment technology ensures the same contact reliability for thin gold plating as that of thick gold plating.



- Improvement in resistance to corrosion
- Improvement in contact reliability for digital signals

3. It is constructed with impact dispersion keys inside the body to

disperse shocks when dropped. Impact dispersion key



A high level of shock resistance is ensured by dispersing impact over the four locations where the socket indentations and header protrusions are mated together.

Note: The following numbers of contacts are not supported due to suction surface factors.

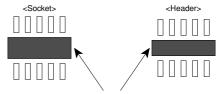
NARROW PITCH (0.4mm) CONNECTORS P4 SERIES

· Without retention fitting: 18 contacts or less

· With retention fitting: 22 contacts or less 4. Construction makes designing

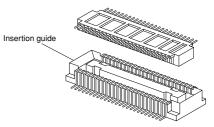
devices easier.

1) The lower connector bottom surface construction prevents contact and shorts between the PCB and metal terminals. This enables freedom in pattern wiring, helping to make PCB's smaller.



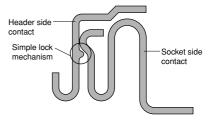
Connector bottom: Create any thru-hole and pattern wiring

2) Guides are provided to take up any position shift and facilitate insertion.



3) The connector has a simple lock mechanism.

Superior mated operation with click feel to indicate that mated is complete.



5. Design makes efficient mounting. Features a terminal flatness of 0.08 mm, construction resistant to creeping flux, and design that facilitates visual inspection of the soldered part. 6. Compliance with RoHS Directive Environmentally friendly, the connectors comply with Europe's RoHS Directive. Cadmium, lead, mercury, hexavalent chromium, PBB and PBDE are not used. 7. Connectors for inspection available Connectors for inspection are available that are ideal for modular unit inspection and inspection in device assembly processes.

APPLICATIONS

Compact portable devices "Cellular phones, DVC, Digital cameras, etc"

Ideal for Board-to-FPC connections Reinforcing plate FPC Before Narrow-pitchmating ÷ ٦. connectors P4 PCB ŧ After \sim 1.5mm mating The simple lock mechanism ensures that the connector clicks into position when it is inserted for reliable single-action insertion on the PCB. This enables the number of pins Inis enables the number of pins to be doubled while the size re-mains the same as that for exist-ing FPC connectors. This, in turn, contributes to making products and equipment more compact.

TABLE OF PRODUCT TYPES

P4 (0.4 mm pitch): Without retention fitting



m in : Available for sale							
Ma hei	ted ght	1.5mm	2.0mm	2.5mm	3.0mm	3.5mm	4.0mm
	14	\$	☆	\$			
	16	☆					
	20	\$	섟	\$			
	22	☆					
	24	☆	Å	☆			
	26	☆	Å				
	28	\$					
acts	30	☆	Å	☆			
Number of contacts	34	☆	\$7				
fc	36	☆					
er o	40	☆	Å	☆			
ğ	44	☆		☆			
nN	50	\$	\$7	\$			
	54	☆					
	60	☆		☆			
	64	\$					
	70	☆	☆	☆			
	80	\$	47				
	90	\$		\$			
	100	☆	Ż	☆			

P4 (0.4 mm pitch): With retention fitting



☆: Available for sale

	ted ght	1.5mm	2.0mm	2.5mm	3.0mm	3.5mm	4.0mm
	10	\$					
	12	\$					
	20			☆	☆	X	
	22	☆					
	24		\$				
ts	28	☆					
Number of contacts	30	☆					
loc	32			\$			
ofe	34	☆					자
Jer	40	☆		\$	☆		
m	44	\$					
z	46	☆					
	50	☆		\$	☆	X	\$
	60	☆		☆	☆	\$2	
	80	\$	**	☆	☆	\$	\$¢
	90	☆		\$	☆		
	100	☆					

Note: Please contact us regarding numbers of contacts other than those given above.

AXK7, 8 **ORDERING INFORMATION**

ΑΧΚ			
7: Narrow Pitch Connector P4 (0.4 mm pitch) Socket 8: Narrow Pitch Connector P4 (0.4 mm pitch) Header			
Number of contacts (2 digits)			
Mated height <pre><socket> 1: For mated height 1.5 mm 2: For mated height 2.0 mm 3: For mated height 2.5 mm and 3.0 mm 4: For mated height 3.5 mm 5: For mated height 4.0 mm <header> 1: For mated height 1.5 mm, 2.0 mm and 2.5 mm</header></socket></pre>			
2: For mated height 3.0 mm, 3.5 mm and 4.0 mm Functions 1: With retention fitting, with positioning bosses 2: With retention fitting, without positioning bosses 3: Without retention fitting, with positioning bosses 4: Without retention fitting, without positioning bosses			
Surface treatment (Contact portion / Terminal portion) <socket> 5: Ni plating on base, Au plating on surface 7: Ni plating on base, Au plating on surface (for Ni barrier product available) <header> 5: Ni plating on base, Au plating on surface</header></socket>			
Other specifications <header> Y: V notch type product W:V notch and post edge horseshoe bend type product Note*</header>			
Packing G: 3 000 pieces embossed tape and plastic reel × 2*			_

* Only a socket of mated height 3.5 mm and 4.0 mm: 2,000 pieces embossed tape and plastic reel \times 2.

lote:

Note: The post edge horseshoe bend indicated by the "W" in he tenth digit of the header part number refers to a construction that makes it difficult for the header post value to defarm when the dge to deform when the onnector is inserted and emoved at an angle.

PRODUCT TYPES 1. Without retention fitting **TDUGH CONTRET**

			Part number		Pac	king
	Neural	Socket	He	ader		
Mated height	Number of contacts	TOUGH CONTRET	TOUGH CONTRET	TDUGH CONTRET and Post edge horseshoe bend type (Recommendation)	Inner carton	Outer carto
	14	AXK714147G	AXK814145YG	AXK814145WG		
	16	AXK716147G	AXK816145YG	AXK816145WG		
	20	AXK720147G	AXK820145YG	AXK820145WG		
	22	AXK722147G	AXK822145YG	AXK822145WG		
	24	AXK724147G	AXK824145YG	AXK824145WG		
	26	AXK726147G	AXK826145YG	AXK826145WG		
	28	AXK728147G	AXK828145YG	AXK828145WG		
	30	AXK730147G	AXK830145YG	AXK830145WG		
	34	AXK734147G	AXK834145YG	AXK834145WG		
4.5	36	AXK736147G	AXK836145YG	AXK836145WG		0.000 sizes
1.5 mm	40	AXK740147G	AXK840145YG	AXK840145WG	3,000 pieces	6,000 piece
	44	AXK744147G	AXK844145YG	AXK844145WG		
	50	AXK750147G	AXK850145YG	AXK850145WG		
-	54	AXK754147G	AXK854145YG	AXK854145WG		
	60	AXK760147G	AXK860145YG	AXK860145WG		
	64	AXK764147G	AXK864145YG	AXK864145WG		
	70	AXK770147G	AXK870145YG	AXK870145WG		
	80	AXK780147G	AXK880145YG	AXK880145WG		
_	90	AXK790147G	AXK890145YG	AXK890145WG		
	100	AXK700147G	AXK800145YG	AXK800145WG		
	14	AXK714247G	AXK814145YG	AXK814145WG		
	20	AXK720247G	AXK820145YG	AXK820145WG		
	24	AXK724247G	AXK824145YG	AXK824145WG		
	26	AXK726247G	AXK826145YG	AXK826145WG		
	30	AXK730247G	AXK830145YG	AXK830145WG		
2.0 mm	34	AXK734247G	AXK834145YG	AXK834145WG	3,000 pieces	6,000 piece
	40	AXK740247G	AXK840145YG	AXK840145WG		
	50	AXK750247G	AXK850145YG	AXK850145WG		
	70	AXK770247G	AXK870145YG	AXK870145WG		
	80	AXK780247G	AXK880145YG	AXK880145WG		
	100	AXK700247G	AXK800145YG	AXK800145WG		
	14	AXK714347G	AXK814145YG	AXK814145WG		
	20	AXK720347G	AXK820145YG	AXK820145WG		
	24	AXK724347G	AXK824145YG	AXK824145WG		
	30	AXK730347G	AXK830145YG	AXK830145WG		
	40	AXK740347G	AXK840145YG	AXK840145WG		
2.5 mm	44	AXK744347G	AXK844145YG	AXK844145WG	3,000 pieces	6,000 piece
	50	AXK750347G	AXK850145YG	AXK850145WG		
	60	AXK760347G	AXK860145YG	AXK860145WG		
	70	AXK770347G	AXK870145YG	AXK870145WG		
	90	AXK790347G	AXK890145YG	AXK890145WG		
	100	AXK700347G	AXK800145YG	AXK800145WG		

Notes: 1. Regarding ordering units; During production: Please make orders in 1-reel units. Samples for mounting confirmation: Available in units of 50 pieces. Please consult us. (See "Regarding sample orders to confirm proper mounting" on page 13.) Samples: Small lot orders are possible.

The standard type comes without positioning bosses. Connectors with positioning bosses are available on-demand production. For this type of connector, 8th digit of the part number changes from 4 to 3. e.g. Mated height 1.5 mm and 20 contacts for socket without retention fitting: AXK720137G

3. The 10th digit "Y" in the header part number indicates the connector has V notch. (For details, please refer to page 36.) "W" indicates a product with V notch and post edge horseshoe bend. ("Post edge horseshoe bend" refers to a construction that makes it difficult for the header post edge to deform when the connector is inserted and removed at an angle.) "Products with V notch" and "products with V notch and post edge horseshoe bend" are mating compatible. 4. Connectors of different mated height (3.0 mm, 3.5 mm and 4.0 mm) and different number of contacts are available on-demand production only. Please contact us

for more details.

SPECIFICATIONS

1. Characteristics

	Item	Specifications	Conditions
	Rated current	0.3A/contact (Max. 5 A at total contacts)	
	Rated voltage	60V AC/DC	
Electrical	Breakdown voltage	150V AC for 1 min.	Detection current: 1mA
characteristics	Insulation resistance	Min. 1,000M Ω (initial)	Using 250V DC megger (applied for 1 min.)
Contact resistance	Max. 70mΩ	Measured based on the HP4338B measurement method of JIS C 5402	
	Composite insertion force	Max. 0.981N {100gf}/contacts × contacts (initial)	
Mechanical characteristics	Composite removal force	Min. 0.0588N {6gf}/contacts × contacts (Mated height 1.5 mm, without removal and retention fitting) Min. 0.118N {12gf}/contacts × contacts (Mated height 1.5 mm, except without removal and retention fitting)	
Post holding force	Min. 0.981N {100gf}/contacts	Measures the maximum load in the post axial direction until removal	
	Ambient temperature	–55°C to +85°C	No freezing at low temperatures
	Soldering heat resistance	Max. peak temperature of 245°C	Infrared reflow soldering
	Soldening heat resistance	300°C within 5 sec. 350°C within 3 sec.	Soldering iron
	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Sequence 1. –55 - 3°C, 30 minutes 2. ~, Max. 5 minutes 3. 85 * 3°C, 30 minutes 4. ~, Max. 5 minutes
Environmental characteristics	Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Bath temperature 40±2°C, humidity 90 to 95% R.H.
(head H ₂ S re	Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Bath temperature $35\pm2^{\circ}C$, saltwater concentration $5\pm1\%$
	H ₂ S resistance (header and socket mated)	48 hours, contact resistance max. $70m\Omega$	Bath temperature 40±2°C, gas concentration 3±1 ppm, humidity 75 to 80% R.H.
Lifetime characteristics	Insertion and removal life	50 times	Repeated insertion and removal speed of max 200 times/hours
Unit weight		Mated height 1.5mm, 20 contacts; Socket: 0.04g Header: 0.02g	

2. Material and surface treatment

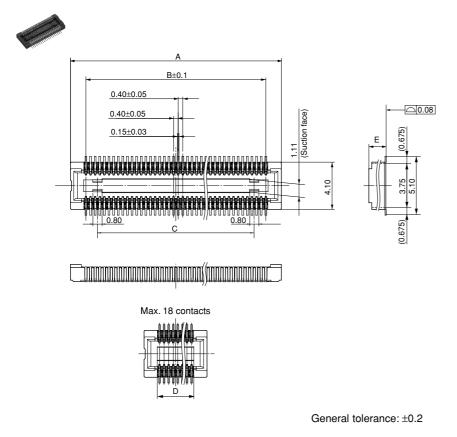
Part name	Material	Surface treatment
Molded portion	Heat-resistant resin (UL94V-0), Black	_
Contact and Post	Copper alloy	Contact portion: Ni plating on base, Au plating on surface Terminal portion: Ni plating on base, Au plating on surface (Except for thick of terminal) However, upper terminal of Ni barrier production: Exposed over Ni The area adjacent to the terminal of the sockets on models with Ni barrier is exposed to Ni on base.
Retention fitting portion	Copper alloy	Ni plating on base, Sn plating on surface (Except for front terminal)

AXK7, 8

DIMENSIONS (mm)

1. Without Retention Fitting

Socket (Mated height: 1.5 mm, 2.0 mm, and 2.5 mm)



Number of contacts/ dimension	Α	В	С
14	5.1	2.4	—
16	5.5	2.8	—
20	6.3	3.6	1.6
22	6.7	4.0	2.0
24	7.1	4.4	2.4
26	7.5	4.8	2.8
28	7.9	5.2	3.2
30	8.3	5.6	3.6

9.1

9.5

10.3

11.1

12.3

13.1

14.3

15.1

16.3

18.3

20.3

22.3

6.4

6.8

7.6

8.4

9.6

10.4

11.6

12.4

13.6

15.6

17.6

19.6

4.4

4.8

5.6

6.4

7.6

8.4

9.6

10.4

11.6

13.6

15.6

17.6

D

2.8

3.2

Dimension table (mm)

34

36

40

44

50

54

60

64 70

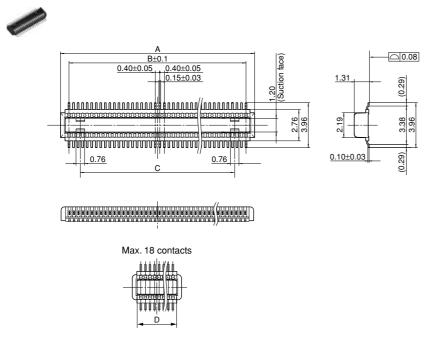
80

90

100

Mated height/dimension	E
1.5mm	1.50
2.0mm	1.92
2.5mm	2.42

Header (Mated height: 1.5 mm, 2.0 mm, and 2.5 mm "products with V notch")



Dimension table (mm)

Number of contacts/ dimension	А	В	С	D
14	3.9	2.4	—	3.04
16	4.3	2.8	_	3.44
20	5.1	3.6	1.6	_
22	5.5	4.0	2.0	—
24	5.9	4.4	2.4	—
26	6.3	4.8	2.8	
28	6.7	5.2	3.2	_
30	7.1	5.6	3.6	_
34	7.9	6.4	4.4	—
36	8.3	6.8	4.8	—
40	9.1	7.6	5.6	—
44	9.9	8.4	6.4	—
50	11.1	9.6	7.6	—
54	11.9	10.4	8.4	—
60	13.1	11.6	9.6	—
64	13.9	12.4	10.4	_
70	15.1	13.6	11.6	_
80	17.1	15.6	13.6	_
90	19.1	17.6	15.6	_
100	21.1	19.6	17.6	—

General tolerance: ±0.2

Note: "Products with V notch" and "products with V notch and post edge horseshoe bend" are mating compatible.



Camera Module Pinout Definition Reference Chart

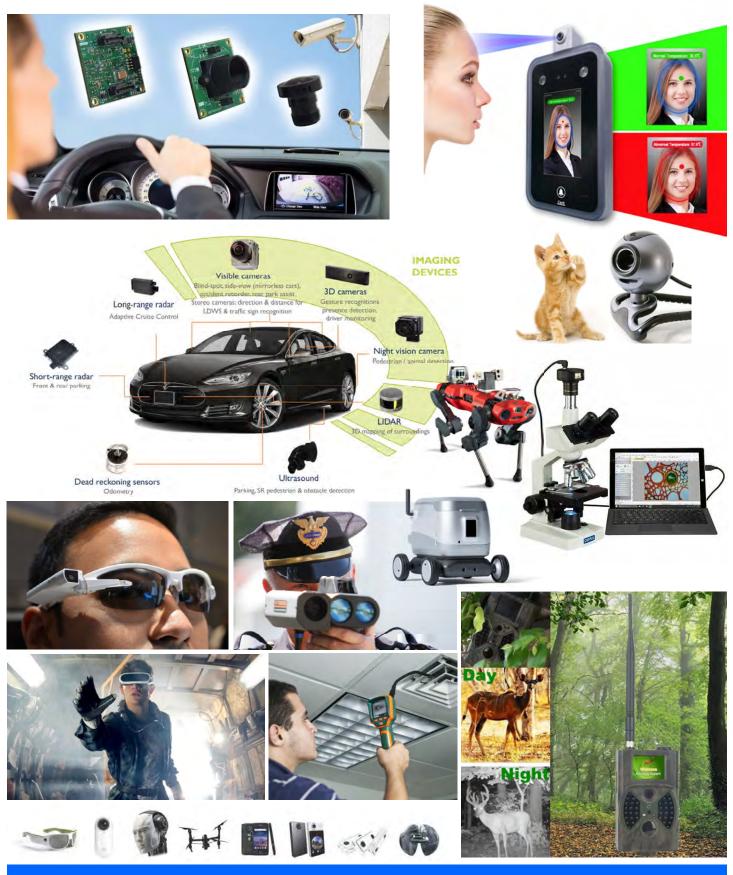
OmniVision Sony Samsung On-Semi Ap	tina Himax GalaxyCore PixArt SmartSens Sensors
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2 N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2 P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3 N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3 P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4 N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 D00 Y0	DVP data output port 0
D1 D01 Y1	DVP data output port 1
D2 D02 Y2	DVP data output port 2
D3 D03 Y3	DVP data output port 2
D4 D04 Y4	DVP data output port 3
D5 D05 Y5	DVP data output port 5
D6 D06 Y6	DVP data output port 6
D7 D07 Y7	DVP data output port 7
D8 D08 Y8	DVP data output port 7
D9 D09 Y9	DVP data output port 9
D10 D010 Y10	DVP data output port 9 DVP data output port 10
D11 D011 Y11	DVP data output port 10 DVP data output port 11
	עשר שמומ שעוףטו דיו

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Cameras Applications

8

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Camera Reliability Test

	Reliability Inspect	ion Item	Testing Mathed	A coopton on Crittoria	
Category		Item	Testing Method	Acceptance Criteria	
Environmental	Storage	High 60°C 96 Hours Temperature Chamber		No Abnormal Situation	
	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation	
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation	
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
		With Package 60cm	10 Times on Wood Floor	Electrically Functional	
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional	
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional	
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional	



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Camera Inspection Standard

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Inspection Item			Inspection Method	Standard of Inspection	
Category		Item	Inspection Method	Standard of Inspection	
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.	
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Lens -	Scratch	The Naked Eye	No Effect On Resolution Standard	
		Contamination	The Naked Eye	No Effect On Resolution Standard	
		Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
Function	Image	No Communication	Test Board	Not Allowed	
		Bright Pixel	Black Board	Not Allowed In the Image Center	
		Dark Pixel	White board	Not Allowed In the Image Center	
		Blurry	The Naked Eye	Not Allowed	
		No Image	The Naked Eye	Not Allowed	
		Vertical Line	The Naked Eye	Not Allowed	
		Horizontal Line	The Naked Eye	Not Allowed	
		Light Leakage	The Naked Eye	Not Allowed	
		Blinking Image	The Naked Eye	Not Allowed	
		Bruise	Inspection Jig	Not Allowed	
		Resolution	Chart	Follows Outgoing Inspection Chart Standard	
		Color	The Naked Eye	No Issue	
		Noise	The Naked Eye	Not Allowed	
		Corner Dark	The Naked Eye	Less Than 100px By 100px	
		Color Resolution	The Naked Eye	No Issue	
Dimension		Height	The Naked Eye	Follows Approval Data Sheet	
		Width	The Naked Eye	Follows Approval Data Sheet	
		Length	The Naked Eye	Follows Approval Data Sheet	
		Overall	The Naked Eye	Follows Approval Data Sheet	

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YDSCAM Package Solutions

YDS Camera Module



Tray with Grid and Space

Complete with Lens Protection Film



Place Cameras on the Tray





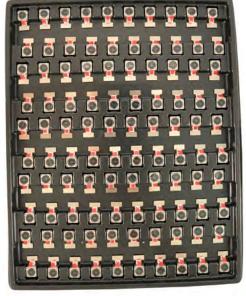
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YDSCAM Package Solutions

Full Tray of Cameras

DS



Place Tray into Anti-Static Bag

Cover Tray with Lid



Vacuum the Anti-Static Bag



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YDSCAM Package Solutions

Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution



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YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags



Place Foam Sheets and Trays into Box



Seal the Carbon Box



Foam Sheets are Larger Than Trays



Foam Sheets are Tightly Fitting in Box



Label the Carbon Shipping Box



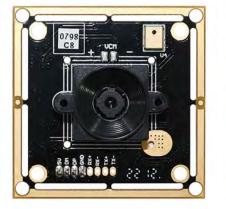
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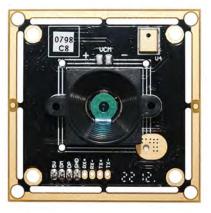


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YDSCAM Package Solutions

USB Camera Module







Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray







Seal the Tray with Anti-Static Bag



Label the Carbon Shipping Box



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Complete with Lens Protection Film



YDSCAM Package Solutions

Place Camera Sample into Anti-Static Bag





Label the Sample Bags

Place Connectors into Anti-Static Bag



Place Connectors into Reel



Place Samples into the Carbon Box





Place Connectors into the Carbon Box



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YDS

Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website <u>www.YDSCAM.com</u>. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequential events.



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YDS Strength

Y

Powerful Factory



Professional Service



Promised Delivery



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